

Electronic Filing System (EFS) Data  
Electronic Patent Application Submission  
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EFS ID: 20309  
Application ID: 10065874  
Title of Invention: METHOD FOR FABRICATING  
POLYSILICON LAYER  
First Named Inventor: Chia-Tien Peng  
Domestic/Foreign Application: Domestic Application  
Filing Date: null  
Effective Receipt Date: 2002-11-27  
Submission Type: Utility Patent Filing  
Filing Type: new-utility  
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Attorney Docket Number: 9788-US-PA  
Digital Certificate Holder: cn=Belinda Lee, ou=Registered Attorneys, ou=Patent and  
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Government, c=US  
Certificate Message Digest: ZCgj3D61vxRSv92k8+l7OQ==  
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# TRANSMITTAL FORM

Electronic Version 1.0.3

Stylesheet Version: 1.0

Submission Type: Utility Patent  
Filing

Attorney Docket  
Number:

9788-US-  
PA

## METHOD FOR FABRICATING POLYSILICON LAYER

First Named Inventor: Mr. Chia-Tien Peng

### SUBMITTED BY

Name:	Dr. Belinda Lee
Registration Number:	46863
Electronic Signature Mark: /Belinda Lee/	Date Signed: 20021127

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*I, the undersigned, certify that I have viewed a display of document(s) being electronically submitted to the United States Patent and Trademark Office, using either the USPTO provided style sheet or software, and that this is the document(s) I intend for initiation or further prosecution of a patent application noted in the submission. This document(s) will become part of the official electronic record at the USPTO.*

### Attached Files:

declaration	9788declaration1.tif
declaration	9788declaration2.tif
specification	9788usf.xml
patent-assignments	9788usasgn.xml

fee-transmittal  
bibd-transmittal

9788usfee.xml  
9788usapds.xml

Attached Image File(s):

9788declaration1.tif  
9788declaration2.tif

Comments:

## COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

## METHOD FOR FABRICATING POLYSILICON LAYER

the specification of which

X is attached hereto.

\_\_\_\_\_ was filed on \_\_\_\_\_

as Application Serial No. \_\_\_\_\_ and was amended on \_\_\_\_\_.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s):

Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
91121833	Taiwan, R.O.C.	2002/9/24	X	

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

**Belinda Lee** (Reg. No. 46,863)  
**Jiawei Huang** (Reg. No. 43,330)  
**Charles C.H. Wu** (Reg. No. 39,081)

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**Belinda Lee**

## COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature: Chia-Tien Peng Date: 2002/01/31

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# FEE TRANSMITTAL

Electronic Version 1.1.0

Stylesheet Version: 1.0

*Patent fees are subject to annual revisions on or about October 1st of each year.*

Large Entity

**TOTAL FEES AUTHORIZED: \$ 780**

## BANK (CREDIT) CARD INFORMATION:

Credit Card Number: 3109  
 Expiration Date: 20030430  
 Authorized Name: LEE, HUI-LU  
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## BASIC FILING FEE

Fee Description	Fee Code	Fee Paid
Utility Filing Fee	1001	\$ 740

Subtotal For Basic Filing Fee: \$ 740

## EXTRA CLAIM FEES

	Fee Code	Fee	Extra Claims	Fee Paid
Total Claims: 20	1202	\$ 18	0	\$ 0
Independent Claims: 2	1201	\$ 84	0	\$ 0

Subtotal For Extra Claims Fees: \$ 0

## ADDITIONAL FEES

Fee Description	Number	Quantity	Fee Code	Amount	Fee Paid
Recording Each Patent Assignment Per Property Fee	00000000	1	8021	\$ 40	\$ 40

Subtotal For Additional Fees: \$ 40